





**Electrical Characteristics (T<sub>c</sub>=25 °C, unless otherwise noted)**

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Units
<b>Off Characteristic</b>						
V <sub>(BR)DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V, I <sub>D</sub> = -250μA	-30	-	-	V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = -30V, V <sub>GS</sub> =0V	-	-	-1	μA
I <sub>GSS</sub>	Gate to Body Leakage Current	V <sub>DS</sub> =0V, V <sub>GS</sub> =±20V	-	-	±100	nA
<b>On Characteristics</b>						
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> = -250μA	-1.0	-1.6	-2.5	V
R <sub>DS(on)</sub> note3	Static Drain-Source on-Resistance	V <sub>GS</sub> = -10V, I <sub>D</sub> = -10A	-	21	25	mΩ
		V <sub>GS</sub> = -4.5V, I <sub>D</sub> = -5A	-	31	40	
<b>Dynamic Characteristics</b>						
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> = -15V, V <sub>GS</sub> =0V, f=1.0MHz	-	1240	-	pF
C <sub>oss</sub>	Output Capacitance		-	151	-	pF
C <sub>rss</sub>	Reverse Transfer Capacitance		-	138	-	pF
Q <sub>g</sub>	Total Gate Charge	V <sub>DS</sub> = -15V, I <sub>D</sub> = -6A, V <sub>GS</sub> = -10V	-	24	-	nC
Q <sub>gs</sub>	Gate-Source Charge		-	3.7	-	nC
Q <sub>gd</sub>	Gate-Drain("Miller") Charge		-	4.8	-	nC
<b>Switching Characteristics</b>						
t <sub>d(on)</sub>	Turn-on Delay Time	V <sub>DD</sub> = -15V, I <sub>D</sub> = -10A, V <sub>GS</sub> = -10V, R <sub>GEN</sub> =3Ω	-	11	-	ns
t <sub>r</sub>	Turn-on Rise Time		-	5.5	-	ns
t <sub>d(off)</sub>	Turn-off Delay Time		-	3.5	-	ns
t <sub>f</sub>	Turn-off Fall Time		-	4.6	-	ns
<b>Drain-Source Diode Characteristics and Maximum Ratings</b>						
I <sub>s</sub>	Maximum Continuous Drain to Source Diode Forward Current	-	-	-30	-	A
I <sub>SM</sub>	Maximum Pulsed Drain to Source Diode Forward Current	-	-	-40	-	A
V <sub>SD</sub>	Drain to Source Diode Forward Voltage	V <sub>GS</sub> =0V, I <sub>s</sub> = -10A	-	-	-1.2	V

Notes:1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature

2. EAS condition: T<sub>J</sub>=25°C, V<sub>DD</sub>=-15V, V<sub>G</sub>=-10V, R<sub>G</sub>=25Ω, L=0.1mH, I<sub>AS</sub>= -27A

3. Pulse Test: Pulse Width≤300μs, Duty Cycle≤2%

## N-Channel Typical Characteristics

Figure 1: Output Characteristics

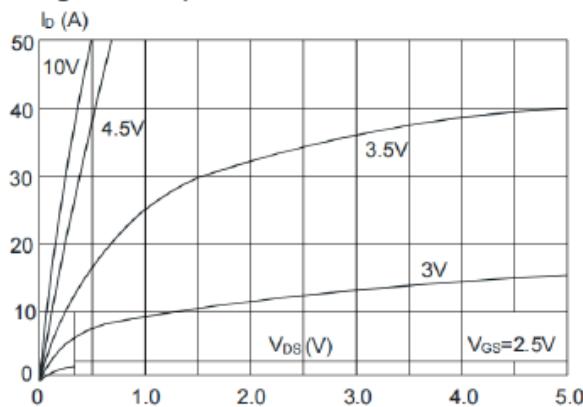


Figure 2: Typical Transfer Characteristics

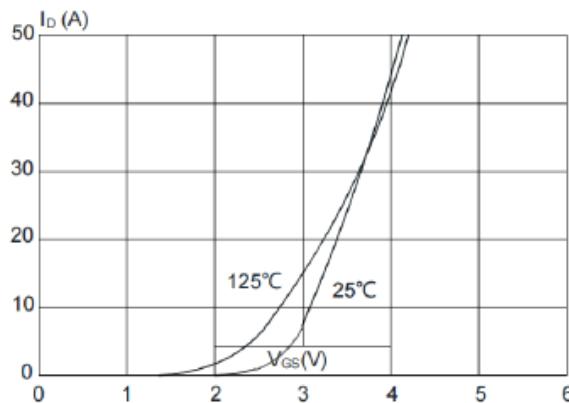


Figure 3: On-resistance vs. Drain Current

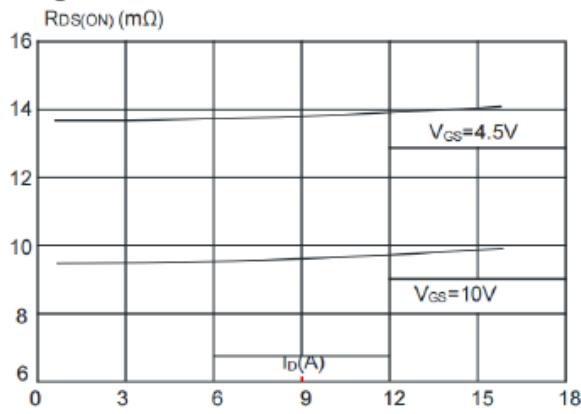


Figure 5: Gate Charge Characteristics

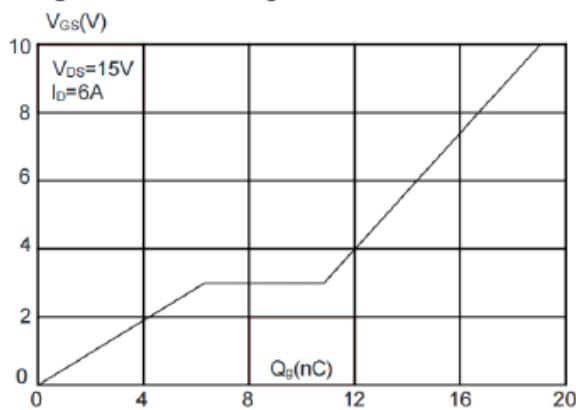


Figure 4: Body Diode Characteristics

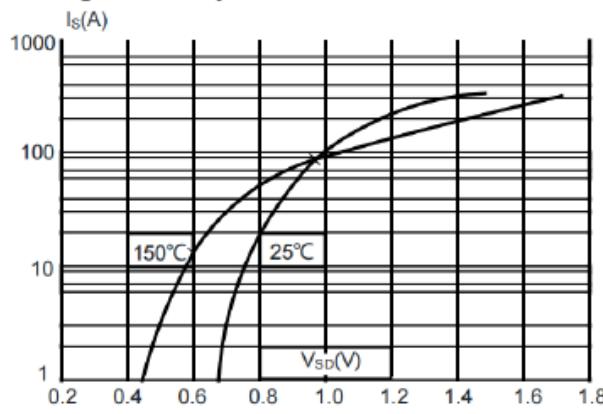
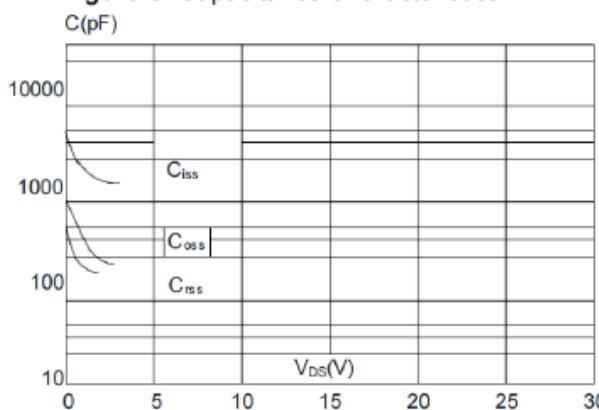


Figure 6: Capacitance Characteristics



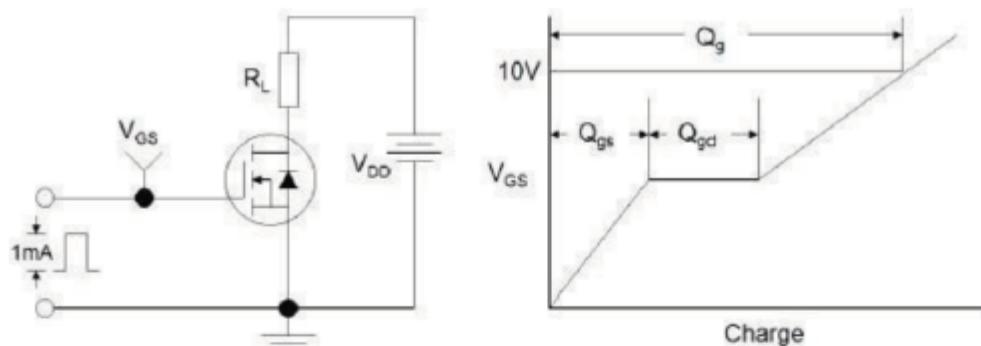


Figure1:Gate Charge Test Circuit &amp; Waveform

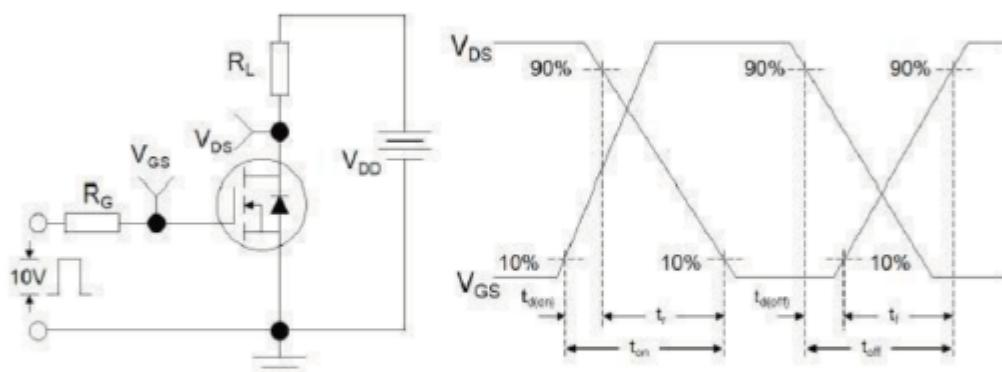


Figure 2: Resistive Switching Test Circuit &amp; Waveforms

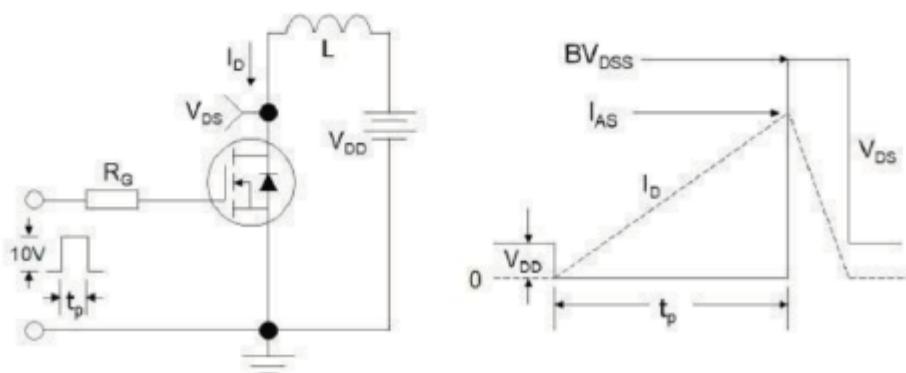
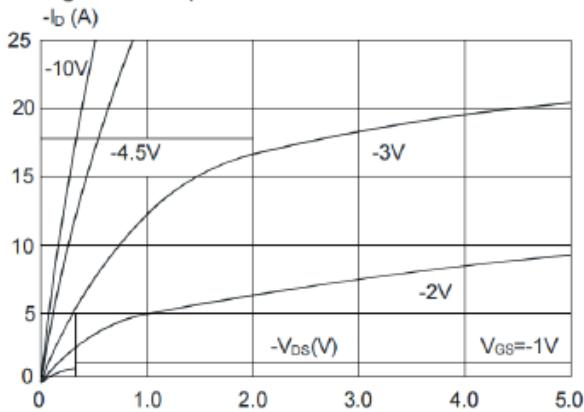
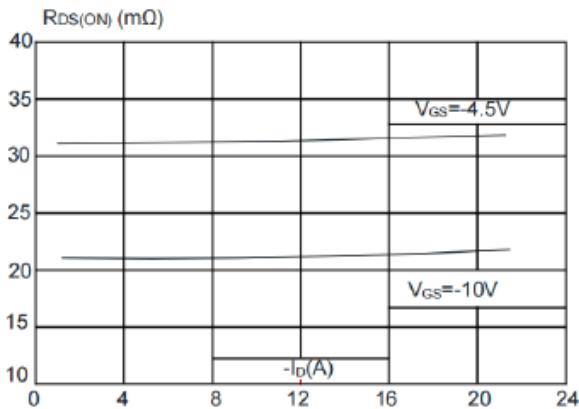
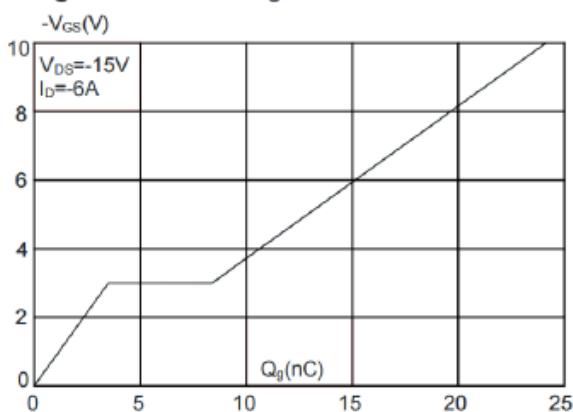
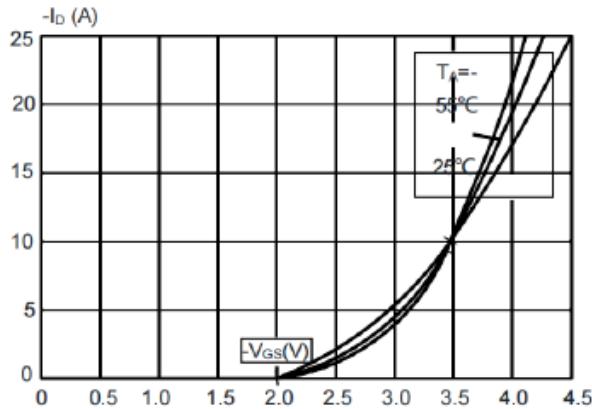
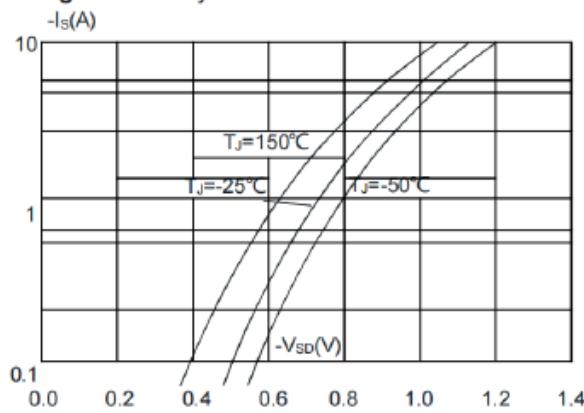
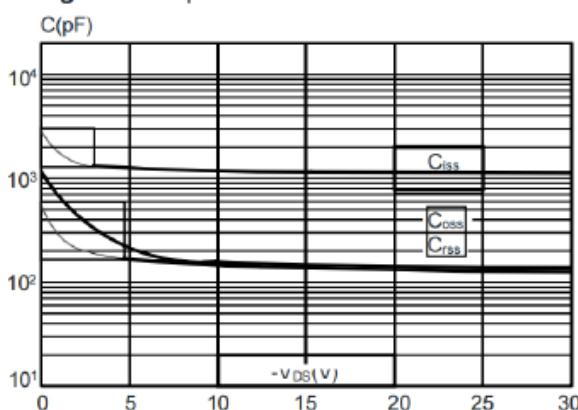
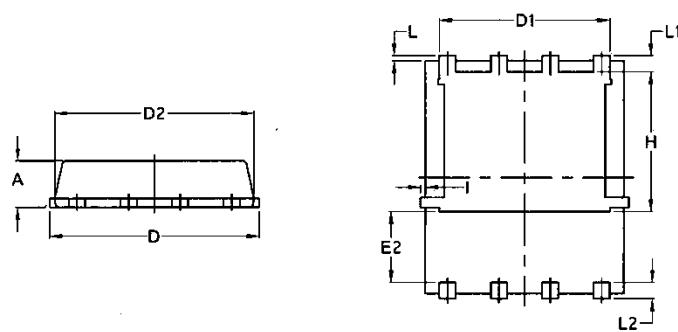
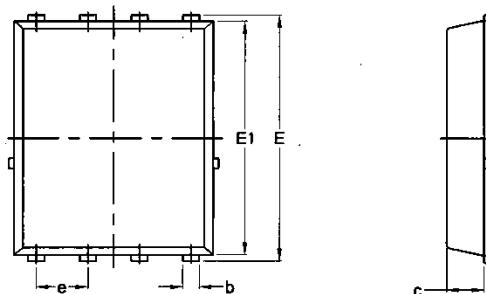


Figure 3:Unclamped Inductive Switching Test Circuit &amp; Wavefor

### P-Channel Typical Characteristics

**Figure1:** Output Characteristics**Figure 3:** On-resistance vs. Drain Current**Figure 5: Gate Charge Characteristics****Figure 2:** Typical Transfer Characteristics**Figure 4:** Body Diode Characteristics**Figure 6: Capacitance Characteristics**



**Package Mechanical Data-DFN5\*6-8L-JQ Single**


Symbol	Common			
	mm		Inch	
	Mim	Max	Min	Max
A	1.03	1.17	0.0406	0.0461
b	0.34	0.48	0.0134	0.0189
c	0.824	0.0970	0.0324	0.082
D	4.80	5.40	0.1890	0.2126
D1	4.11	4.31	0.1618	0.1697
D2	4.80	5.00	0.1890	0.1969
E	5.95	6.15	0.2343	0.2421
E1	5.65	5.85	0.2224	0.2303
E2	1.60	/	0.0630	/
e	1.27 BSC		0.05 BSC	
L	0.05	0.25	0.0020	0.0098
L1	0.38	0.50	0.0150	0.0197
L2	0.38	0.50	0.0150	0.0197
H	3.30	3.50	0.1299	0.1378
I	/	0.18	/	0.0070